DSD/DSL SERIES

SLIDE END STACKABLE "SMT" TYPE





Features

- End stackable for standard 0.100" integrated circuit pitch.
- Molded 0.300" integrated circuit packting outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board wave soldering.
- Top tape sealed to withstand wave soldering, board washing.

♦ Specifications

1. ELECTRICAL

- 1-1 Contact Rating
 - switching
- : 25 mA, 24 VDC
- non-switching 1-2 Contact Resistance
 - initial
 - after life test
- 1-3 Insulation Resistance
- 1-4 Dielectric Strength
- 1-5 Capacitance between adjacent switches
- : 100 mA
- : 50 mΩ max.
- : 100 mΩ max.
- : 1000 MΩ min. at 100 VDC
- : 500 VDC for 1 min.
- : 5pF max.

2. MECHANICAL and ENVIRONMENTAL

soldering (tin/gold).

2-1 Temperature rating :-25°C to +70°C - operating : -40°C to +85°C - storage 2-2 Operating force : 800 g max. 2-3 Mechanical life : 2000 operations 2-4 Humidity : 95% RH, 40°C for 96 hours 2-5 Vibration : Per MIL-STD-202F, method 204D 2-6 Solderability : 95% coverage after 230°C +/- 5 for 5 sec.

• All materials are UL 94V-0 grade fire retardant plastics.

• Gold plated contact to ensure low contact resistance and

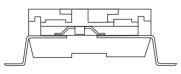
tin plated terminal to prevent contamination during

• Twin contact designed to ensure stable contact.

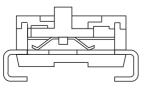
2-7 Soldering temperature : 210°C for 20 sec., 230°C peak for 3 sec.

Construction









Options

- 1. Special marking and case color available
- 2. Extended Actuator



3. Tape sealed



18



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• Dimensions and circuitry

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> 2.54x(P-1)± 0.2 (0.100x(P-1))

 $\frac{11.2 \pm 0.2}{(0.441)}$

(0.181) ± 0.2

4.6 ±

DIMENSION A

Position	1	2	3	4	5	6	7	8	9	10	12
А	2.5	5.04	7.58	10.12	12.66	15.20	17.74	20.28	22.82	25.36	30.43
	(0.098)	(0.198)	(0.298)	(0.398)	(0.498)	(0.598)	(0.698)	(0.798)	(0.898)	(0.998)	(1.198)

Unit: mm (inch)

(0.020)

(0.016)

19

